

Statement of Compliance

Requested Part

08 March 2016

1-215570-8

(Part 1 of 1)

MICRO-MATCH PBC.18P

Part Status:	Active
Mil-Spec Certified:	No
EU RoHS/ELV Code:	Always EU RoHS/ELV Compliant
Solder Process Capability Code:	Wave solder capable to 265°C
China RoHS:	No Restricted Materials Above Threshold

Exemptions: None

Each REACH declaration statement below refers ONLY to the specific SVHCs published to the REACH Candidate List on the Month/Year indicated. TE does not currently provide a cumulative REACH statement related to the most recent Date of Inclusion, or to the total number of substances on the Candidate List.

REACH Oct 2008 SvHC Compliance:	Contains no REACH October 2008 SvHC(s)
REACH Jan/Mar 2010 SvHC Compliance:	Contains no REACH Jan/Mar 2010 SvHC(s)
REACH June 2010 SvHC Compliance:	Contains no REACH June 2010 SvHC(s)
REACH December 2010 SvHC Compliance:	Contains no REACH December 2010 SvHC(s)
REACH June 2011 SvHC Compliance:	Contains no REACH June 2011 SvHC(s)
REACH December 2011 SvHC Compliance:	Contains no REACH December 2011 SvHC(s)
REACH June 2012 SvHC Compliance:	Contains no REACH June 2012 SvHC(s)
REACH December 2012 SvHC Compliance:	Contains no REACH December 2012 SvHC(s)
REACH June 2013 SvHC Compliance:	Contains no REACH June 2013 SvHC(s)
REACH December 2013 SvHC Compliance:	Contains no REACH December 2013 SvHC(s)
REACH June 2014 SvHC Compliance:	Contains no REACH June 2014 SvHC(s)
REACH December 2014 SvHC Compliance:	Contains no REACH December 2014 SvHC(s)

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2).

Additionally, the part numbers that are as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc.). Finished electrical and electronic products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked.

TE's information on SVHC's in articles is currently based on the European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' (Version: 2, April 2011), applying the 0.1% weight on weight concentration threshold at the finished product level. TE is aware of the European Court of Justice ruling of September 10th, 2015 stating that, in case of 'complex articles', the threshold for a SVHC must be applied to both the product as a whole and simultaneously to each of the articles forming part of its composition. To make sure our REACH information stays in line with the changed legal interpretation and industry practices, TE is monitoring evaluations of this new ruling and awaits the expected new ECHA guidance on the practical implementation.



REACH June 2015 SvHC Compliance: REACH December 2015 SvHC Compliance: Halogen Content: Contains no REACH June 2015 SvHC(s) Contains no REACH December 2015 SvHC(s) Not Low Halogen - contains Br or Cl > 900 ppm.



Guy Degrieck Manager, Product Environmental Compliance

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